



Part Number: LP-EM-CC1354P10-1

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CCI3P4bI0-I

Meet the

Connect your LaunchPad to a computer

JuamqolavaC

SmartRF Studio
A powerful application to
evaluate radio performance.
SimpleLink SDK and
SimpleLink Academy
Advanced soffware and
tutorials to easy ramp your
development with your new



Professional Software tools
LaunchPads are supported by

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Software Tools



- 0-200kΩ potentiometer \$>>See them all @ ti.com/boosterpack

BoosferPack
- Flow meter meserrements
- Ultra low power accelerometer
- Walsog Light Sensor
- Analog Light Sensor

SimpleLink ULP Sense

- 1.28 128 x 128 pixel LCD (LS013B7DH03) - microSD card slot - DCDC 3V to SV converter - Ultra-low-power operation

Sharp® 128x128 Memory LCD and microSD card BoosterPack



watch variables, profile code, inspect memory and more.

capability. Set breakpoints,

features and full debug-

provide industrial-grade

professional IDEs that

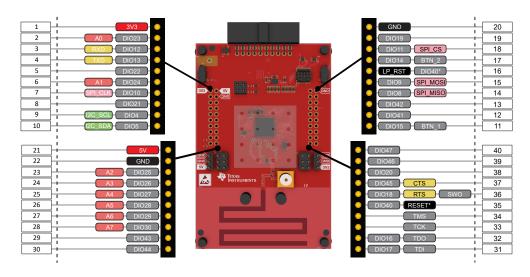
BoosterPack Ecosystem

The BoosterPack™ connector

SPRUIZ8

INSTRUMENTS

The pinout to connect BoosterPack accessories (available separately) are shown below.



UART (DIO12, DIO13), **Reset** (LP_RST) and **JTAG** (TMS, TCK, TDO and TDI) are also present in the LP-EM Debug Connector. Power (**GND**, **3V3** and **5V**) is also provided.

*These functions are not connected to the LaunchPad connector by default.

XDS110 EnergyTrace™ Technology

The LP-EM-CC1354P10-1 is compatible with EnergyTrace technology. EnergyTrace implements a new method for measuring MCU current consumption. It uses a DC-DC solution to measure the time density of charge pulses, allowing accuracy on ultra low power measurements. Its high dynamic range (700 nA to 400 mA) and fast sampling rate (256 kSPS) captures the complete operational profile of the wireless MCU.

EnergyTrace Profile

EnergyTrace Profile runtime and energy data for low power modes along with each function run during Active Mode.

Graphical Power Data in Code Composer Studio

These two tabs of the EnergyTrace Technology window show a graph over time of power and energy.

Available in the LP-XDS110ET Debug Probe and selected LaunchPads

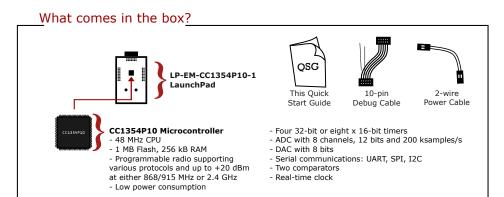
Find more information at ti.com/EnergyTrace

A closer look at your new LaunchPad Development Kit

Featured microcontroller: CC1354P10

This LaunchPad is great for...

- Battery-operated wireless applications operating in the Sub-1 GHz (868 and 915 MHz) and 2.4 GHz ISM RF bands. It features two Sub-1 GHz RF paths up to \pm 14 and \pm 20 dBm and one 2.4 GHz up to \pm 5 dBm
- Adding RF capabilities to your product using one of the supported protocols: Bluetooth LE, Zigbee, IEEE 802.15.4q, Wi-SUN®, Wireless M-Bus, MIOTY® and proprietary protocols



Hardware setup

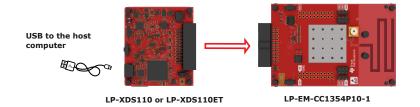
What do you need?

To use your new LaunchPad, you need to connect an external Debug Probe to either the 20-pin LP-EM Debug connector on the edge of the board or to the 10-pin Debug connector and supply power separately.

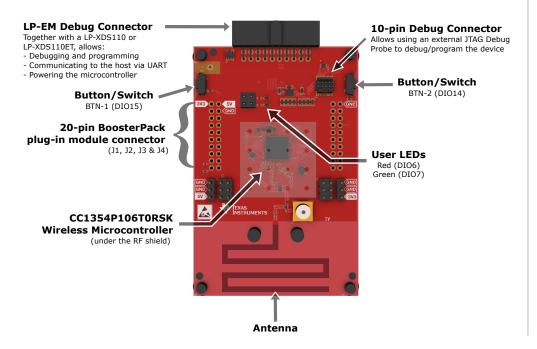
Option 1: Using the LP-EM Debug Connector

This is the easiest way to setup the hardware. It requires either an **LP-XDS110** or **LP-XDS110ET** Debug Probe (sold separately).

Simply connect the edge connector of the Debug Probe to the edge connector of the LaunchPad and connect the USB port of the Debug Probe to the host computer. A secondary UART communications channel will also be available and power to the LaunchPad will be provided directly.



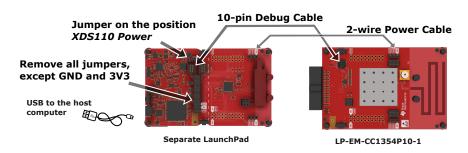
LP-EM-CC1354P10-1 Overview



Option 2: Using the 10-pin debug connector

Either a standalone debug probe or a separate LaunchPad with a built-in debug probe can be used.

Connect the two boards as shown in the picture below:



For additional details, consult dev.ti.com/?id=LP-EM-CC1354P10-1

When using the 10-pin debug connector, the UART communications channel must be wired separately (this connector does not carry UART signals).

If using a standalone Debug Probe, consult its documentation to see if it supports the ARM Cortex-M 10-pin standard.

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